

**KBJ10005G THRU KBJ1010G  
BRIDGE RECTIFIER**

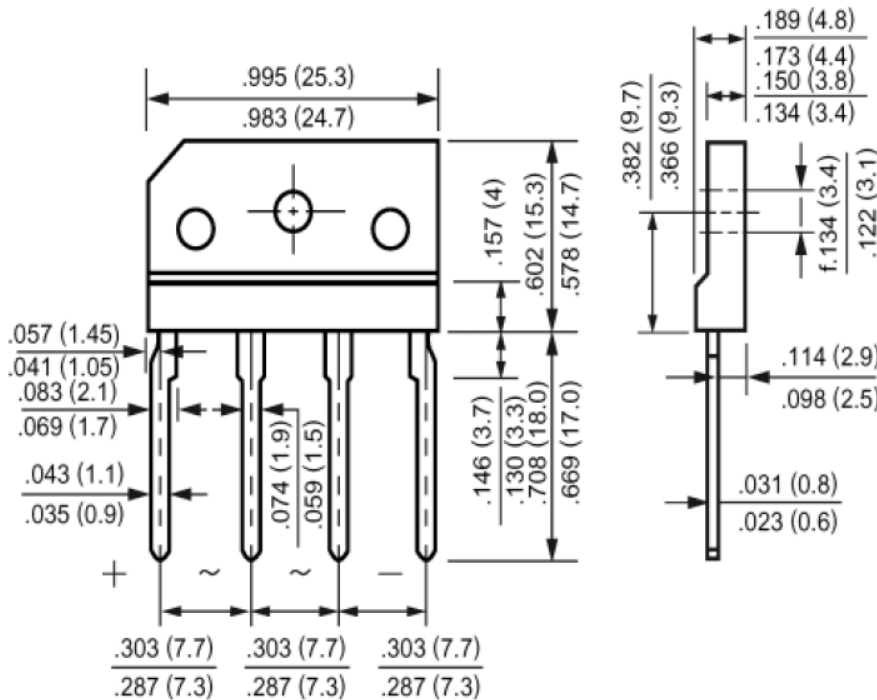
**Features:**

- Glass passivated chip
- Reliable low cost construction utilizing molded plastic technique
- Ideal for printed circuit board
- Low forward voltage drop
- Low reverse leakage current
- High surge current capability

**Mechanical Data:**

- Case: Molded plastic, KBJ
- Epoxy: UL 94V-O rate flame retardant
- Terminals: Leads solderable per MIL-STD-202, method 208 guaranteed
- Mounting position: Any
- Weight: 0.16ounce, 4.6gram

**Mechanical Dimensions: In Inches/mm**



**KBJ**

**MARKING, MOLDING RESIN**

Marking for Type Number, 1st row SSG YYWWL, 2nd row Type Number  
Where YY is the manufacture year  
WW is the manufacture week code  
L is the wafer's Lot Number



## KBJ10005G THRU KBJ1010G

Technical Data  
Data Sheet N1828, Rev. -

Green Products

### Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

#### Maximum Ratings:

Type Number	Symbol	KBJ 10005G	KBJ 1001G	KBJ 1002G	KBJ 1004G	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Maximum Recurrent Peak Reverse Voltage Maximum DC Blocking Voltage	$V_{RRM}$ $V_{DC}$	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_C = 80^\circ\text{C}$	$I_O$	10.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	150							A

#### Electrical Characteristics:

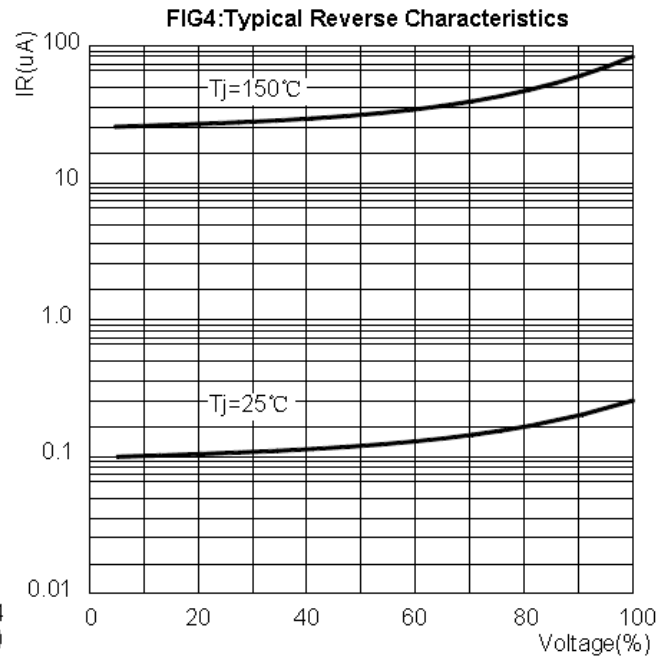
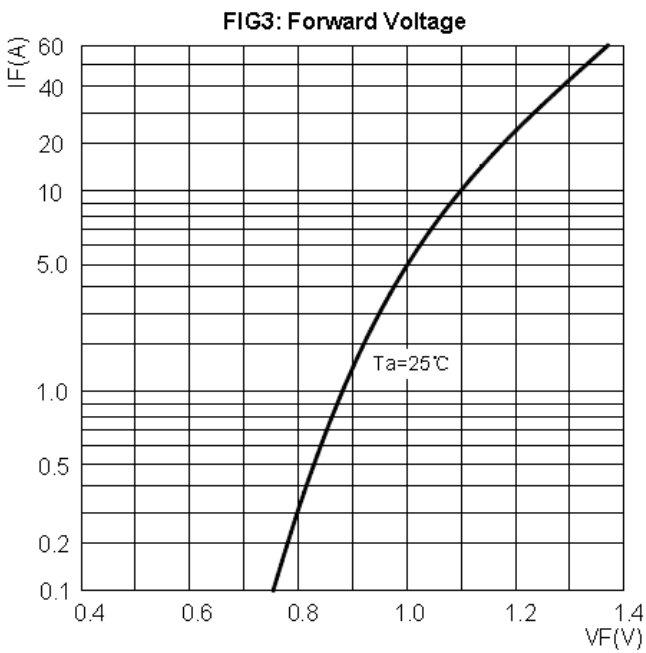
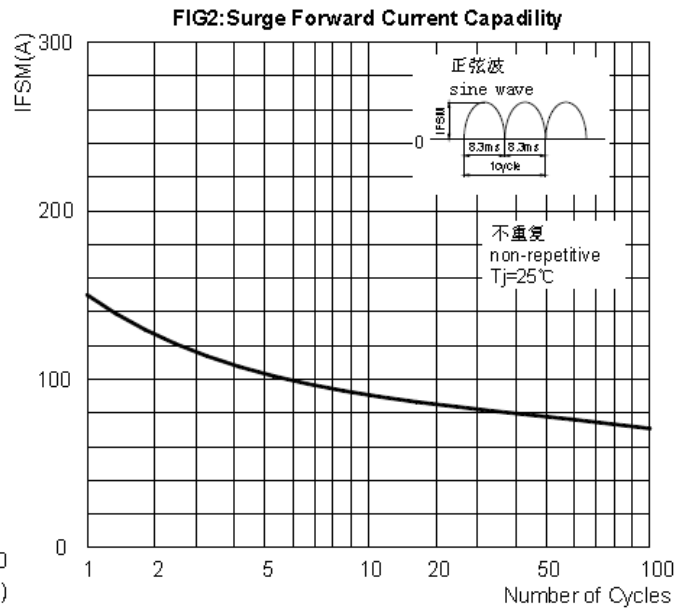
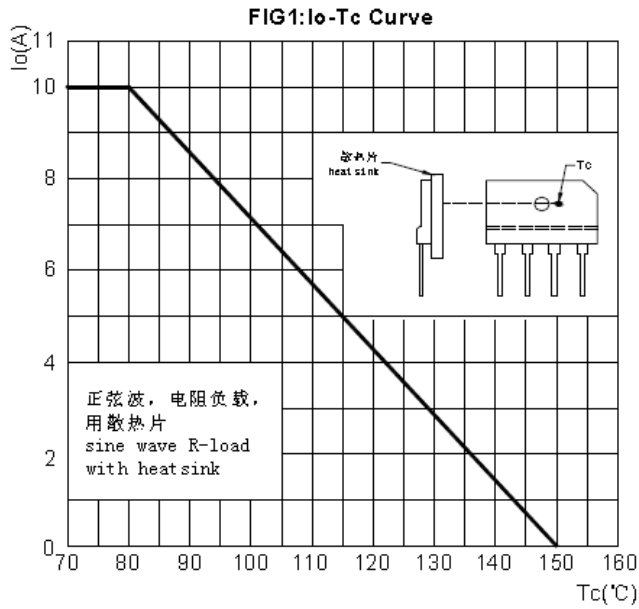
Type Number	Symbol	KBJ 10005G	KBJ 1001G	KBJ 1002G	KBJ 1004G	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Maximum Forward Voltage @ $I_F = 5.0\text{A}$	$V_{FM}$	1.1							V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$	$I_R$	10							$\mu\text{A}$

#### Thermal-Mechanical Specifications:

Type Number	Symbol	KBJ 10005G	KBJ 1001G	KBJ 1002G	KBJ 1004G	KBJ 1006G	KBJ 1008G	KBJ 1010G	Unit
Typical Thermal Resistance (Note 1)	$R_{\theta JC}$	2.3							$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150							$^\circ\text{C}$
Case Style		KBJ							

Note: 1. Between junction and case, with heatsink

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